To,

The candidates (as per list attached)

Subject: Chinese Government Scholarship 2019-20: Confirmation of the award – regarding

Sir/Madam,

I am directed to say that the Government of China has made the final selection for CSC scholarship to study in China in the Academic Year 2019-20 (as per list attached). The details of terms & conditions of the scholarship are as under:-

a) The details of the admission are as per the list attached.

b) Government of India will bear the International passage cost from India to China only and NOT for the return journey from China to India.

c) The admissible scholarship amount will be paid by the Govt. of China.

d) The selected candidates are required to submit the following documents to the Ministry of Human Resource Development:

   I. Bond (FORM A) (Annexure I)
   II. Certificate of Solvency (Annexure II)
   III. Declaration by Sureties (Annexure III)
   IV. Declaration by the Scholar (Annexure IV)
   V. Certificate of Health (Annexure V)
   VI. NOC/Employers Undertaking (if employed) (Annexure VI)
   VII. Cadre Clearance (in case of Government employee)
   VIII. 3 passport size photographs

e) The Candidate must meet the requirement of Foreigner Physical Examination as prescribed by the Government of China. Original copy of the Foreigner Physical Examination Form (Annexure V) is required for issuing visa.

f) The Candidate is required to carry all original certificates for proof of age and educational qualifications etc.


g) The Candidate is required to abide by the regulations issued by the Chinese authorities governing foreign students admitted in Chinese Universities.
h) On return to India after completion of studies, the candidate is required to submit a final report regarding his/her completion of study.

2. The candidate is required to submit the documents complete in all respects to this Ministry latest by Tuesday, 13 August 2019.

3. Admission notice and Visa application for study in China in respect of all selected candidates have been received in the Ministry, which must be collected by the candidates. Candidates are required to apply for Visa at Chinese Visa Application Service Center at Delhi/Kolkata/Mumbai/ as per their jurisdiction.

4. After completion of the formalities and issue of Visa, the candidate may request the Ministry for booking of air ticket. The following documents are required to be submitted for booking of air-ticket:

i) Formal request along with travel plan.
ii) Copy of Passport
iii) Copy of Visa issued

NOTE: It must be clearly noted that such request for booking of air ticket only be made after completion of formalities with this Ministry. After submission of request for booking of air ticket, the Ministry would require minimum 10 days time for booking air ticket. The candidates should keep this in mind and accordingly, they are advised to contact their University/Institution for registration process and deadline. No change in the Travel Plan will be entertained.

5. On arrival in China, the candidate is required to report to the nearest Indian Mission at the following address:

i) **Embassy of India, Beijing**: No. 5, Liang Ma Qiao Bei Jie, Chayoyang District, Beijing – 100600 Tel No. 00-86-10-85312512

ii) **Consulate General of India, Shanghai**: 1008 Shanghai International Trade Centre, 2201 Yan An West Road, Shanghai – 200336, Tel: 62758882/885/886. Extn. 21

iii) **Consulate General of India, Guangzhou**: Units 1401-1404, 14th Floor, HNA Tower 8, Linhe Zhong Road Tianhe District Guangzhou – 510610, China, Tel: 00-86-20-8550

6. The candidate is required to submit the joining report to the Indian Embassy/Consulate General of India in the enclosed pro-forma. The candidate is requested to route his/her correspondence with this Ministry through the Indian Mission there. No direct request of any kind will be entertained. In case of any difficulty, candidate is advised to seek the help of the Indian Mission there.

7. The Candidate is advised to carry some amount of hard currency which he/she may require for personal expenses during the Journey and at the initial stage in China.

8. The Candidate should not accept any employment in any of the Chinese/Indian Institution in China without prior permission of this Ministry.

9. The Candidate is required to complete the course within the approved study period as mentioned in the admission notice issued to them. **No extension would be granted beyond this period.**
10. On return to India after completion of study, the Candidate is required to report to this Ministry (ES.3 Section) and submit the final report about the study in the prescribed pro-forma and photocopies of the degree/diploma obtained in China, otherwise it will be treated as willful violation of the terms and conditions of the Bond and action will be initiated to recover the bond money from the candidate or his/her sureties.

Yours faithfully,

(Visalakshi Jayaraman)
Under Secretary to the Government of India
Tele: 011 26172492

Encl: As above

Copy to:-

1. The Embassy of India, Beijing. With the request that the joining reports of the students may be forwarded to this Ministry after his/her admission is finalized.

2. The Consulate General of India, Shanghai. With the request that the joining reports of the students may be forwarded to this Ministry after his/her admission is finalized.

3. The Consulate General of India, Guangzhou, Units 1401-1404, 14th Floor, HNA Tower 8, Linhe Zhong Road Tianhe District Guangzhou – 510610, China.


5. CMIS, Ministry of Human Resource Development, Shastri Bhawan, New Delhi – 110001 (to upload it on the website of this Ministry)

(Visalakshi Jayaraman)
Under Secretary to the Government of India
<table>
<thead>
<tr>
<th>Sl.No.</th>
<th>Name</th>
<th>Subject</th>
<th>Medium of Language/Instruction</th>
<th>Course Category</th>
<th>University/Institution</th>
<th>Period of Course</th>
<th>Date of Registration</th>
</tr>
</thead>
<tbody>
<tr>
<td>1.</td>
<td>Amit Kumar Vishwakarma</td>
<td>Internet of Things</td>
<td>English</td>
<td>PhD</td>
<td>Tsinghua University</td>
<td>September 2019 to July 2020</td>
<td>04 September 2019 to 05 September 2019</td>
</tr>
<tr>
<td>2.</td>
<td>Shreshtha Sankar Kulsi</td>
<td>Civil Engineering</td>
<td>English</td>
<td>PhD</td>
<td>Chang'an University</td>
<td>September 2019 to July 2023</td>
<td>03 September 2019 to 04 September 2019</td>
</tr>
<tr>
<td>3.</td>
<td>Jakeer Hussain Shaik</td>
<td>Accounting</td>
<td>English</td>
<td>PhD</td>
<td>Southwestern University of Finance and Economics</td>
<td>September 2019 to July 2023</td>
<td>02 September 2019 to 03 September 2019</td>
</tr>
<tr>
<td>4.</td>
<td>Jagriti Jain</td>
<td>Civil Engineering</td>
<td>Chinese</td>
<td>PhD</td>
<td>China University of Geosciences, Wuhan</td>
<td>September 2019 to July 2024</td>
<td>02 September 2019 to 04 September 2019</td>
</tr>
<tr>
<td>5.</td>
<td>Mohamed Sadiq M</td>
<td>Electronics</td>
<td>English</td>
<td>PhD</td>
<td>Zhejiang University</td>
<td>September 2019 to July 2023</td>
<td>02 September 2019 to 03 September 2019</td>
</tr>
<tr>
<td>7.</td>
<td>Dipti Tiwari</td>
<td>Hydrology and Water Resources</td>
<td>English</td>
<td>PhD</td>
<td>Huazhong University of Science and Technology</td>
<td>September 2019 to July 2022</td>
<td>02 September 2019 to 06 September 2019</td>
</tr>
<tr>
<td>8.</td>
<td>Vishnu K J</td>
<td>Communication</td>
<td>English</td>
<td>PhD</td>
<td>Communication University of China</td>
<td>September 2019 to July 2022</td>
<td>05 September 2019</td>
</tr>
<tr>
<td>9.</td>
<td>Praveen Kumar</td>
<td>Electrical Engineering</td>
<td>English</td>
<td>PhD</td>
<td>Huazhong University of Science and Technology</td>
<td>September 2019 to July 2022</td>
<td>02 September 2019 to 06 September 2019</td>
</tr>
<tr>
<td>No.</td>
<td>Name</td>
<td>Field</td>
<td>Language</td>
<td>Degree</td>
<td>University</td>
<td>Duration</td>
<td>Date Range</td>
</tr>
<tr>
<td>------</td>
<td>---------------------</td>
<td>-----------------------------------</td>
<td>----------</td>
<td>--------</td>
<td>-------------------------------------</td>
<td>-----------------------------------------------</td>
<td>---------------------</td>
</tr>
<tr>
<td>10.</td>
<td>Asim Khan</td>
<td>Nanotechnology and Nanomaterials</td>
<td>English</td>
<td>PhD</td>
<td>Beihang University</td>
<td>September 2019 to July 2023</td>
<td>03 September 2019 to 04 September 2019</td>
</tr>
<tr>
<td>11.</td>
<td>Harshita Gupta</td>
<td>International Relations</td>
<td>English</td>
<td>Master's</td>
<td>Zhejiang University</td>
<td>September 2019 to July 2022</td>
<td>02 September 2019 to 03 September 2019</td>
</tr>
<tr>
<td>12.</td>
<td>Divyakshi Kukshal</td>
<td>Business Administration</td>
<td>English</td>
<td>Master's</td>
<td>Peking University</td>
<td>September 2019 to July 2021</td>
<td>On 29 August 2019</td>
</tr>
<tr>
<td>13.</td>
<td>Vishal Kumar</td>
<td>Molecular Medicine</td>
<td>English</td>
<td>Master's</td>
<td>Nanjing Medical University</td>
<td>September 2019 to July 2022</td>
<td>On 01 September 2019</td>
</tr>
<tr>
<td>15.</td>
<td>Ravi Prakash</td>
<td>Environmental Science and New Energy Technology</td>
<td>English</td>
<td>Master's</td>
<td>Harbin Institute of Technology</td>
<td>September 2019 to July 2021</td>
<td>29 August 2019 to 30 August 2019</td>
</tr>
<tr>
<td>17.</td>
<td>Avinash Ray</td>
<td>Business Administration</td>
<td>English</td>
<td>Master's</td>
<td>Shanghai University</td>
<td>September 2019 to March 2022</td>
<td>26 August 2019 to 27 August 2019</td>
</tr>
<tr>
<td>18.</td>
<td>Mahim Jana</td>
<td>Fine Arts</td>
<td>Chinese</td>
<td>Master's</td>
<td>Nanjing University of the Arts</td>
<td>September 2019 to July 2023</td>
<td>On 09 September 2019</td>
</tr>
<tr>
<td>19.</td>
<td>Vivek Kumar</td>
<td>Public Health</td>
<td>English</td>
<td>Master's</td>
<td>Central South University</td>
<td>September 2019 to July 2022</td>
<td>02 September 2019 to 05 September 2019</td>
</tr>
<tr>
<td>20.</td>
<td>Suman Chatterjee</td>
<td>Laser Machining</td>
<td>English</td>
<td>Senior Scholar Program</td>
<td>Shantou University</td>
<td>September 2019 to July 2020</td>
<td>On 05 September 2019</td>
</tr>
<tr>
<td>No.</td>
<td>Name</td>
<td>Course</td>
<td>Language</td>
<td>General Scholar Program</td>
<td>University</td>
<td>Date of Study</td>
<td></td>
</tr>
<tr>
<td>-----</td>
<td>---------------------</td>
<td>-------------------------------------------</td>
<td>----------</td>
<td>------------------------</td>
<td>------------------------</td>
<td>------------------------</td>
<td></td>
</tr>
<tr>
<td>22.</td>
<td>Shubham Kumar</td>
<td>Chinese Language</td>
<td>Chinese</td>
<td>General Scholar Program</td>
<td>Guizhou University</td>
<td>September 2019 to July 2020</td>
<td></td>
</tr>
<tr>
<td>23.</td>
<td>Rachit Garg</td>
<td>Mechanical and Industrial Engineering</td>
<td>English</td>
<td>General Scholar Program</td>
<td>Tsinghua University</td>
<td>September 2019 to July 2020</td>
<td></td>
</tr>
<tr>
<td>24.</td>
<td>Devendra Kumar</td>
<td>Chinese Language</td>
<td>Chinese</td>
<td>General Scholar Program</td>
<td>Tsinghua University</td>
<td>September 2019 to July 2020</td>
<td></td>
</tr>
<tr>
<td>25.</td>
<td>Raj Gupta</td>
<td>Chinese Language and Literature</td>
<td>Chinese</td>
<td>General Scholar Program</td>
<td>Beijing Language and Culture University</td>
<td>September 2019 to July 2020</td>
<td></td>
</tr>
<tr>
<td>26.</td>
<td>Supradip Das</td>
<td>Chinese Language</td>
<td>Chinese</td>
<td>General Scholar Program</td>
<td>Beijing Language and Culture University</td>
<td>September 2019 to July 2020</td>
<td></td>
</tr>
<tr>
<td>27.</td>
<td>Satya Bharati</td>
<td>Chinese Language and Literature</td>
<td>Chinese</td>
<td>General Scholar Program</td>
<td>Tianjin Foreign Studies University</td>
<td>September 2019 to July 2020</td>
<td></td>
</tr>
<tr>
<td>28.</td>
<td>Sachin Rathore</td>
<td>Chinese Language</td>
<td>Chinese</td>
<td>General Scholar Program</td>
<td>Guizhou University</td>
<td>September 2019 to July 2020</td>
<td></td>
</tr>
</tbody>
</table>
FORM-A

(To be used in the case of candidates not employed)

BOND FOR SCHOLARSHIP AWARDEE UNDER THE ________________________________

(Name of the Scholarships/fellowships Scheme)

KNOW ALL MEN BY THESE PRESENT THAT I, ________________________________ (Name of the scholarship awardee)

son/daughter of Shri ________________________________ residing at ________________________________

hereinafter called “scholarship awardee” (which expression shall unless excluded by or repugnant to the context include his/her heirs, administrators and assigns) and

(i) I, ________________________________ (name of the 1st Surety)

son/daughter of Shri ________________________________

residing at ________________________________

(ii) I, ________________________________ (name of the 2nd Surety)

son/daughter of Shri ________________________________

residing at ________________________________

hereinafter called “the sureties” (which expression shall unless excluded by or repugnant to the context include his/her heirs, administrators and assigns) bind ourselves jointly and severally to pay to the President of India (hereinafter called “the Government”) on demand and without demur a sum of Rs.60,000/- (Rupees Sixty Thousand only) and the actual airfare amount spent in connection with the travel of Shri/Ms./Dr. ________________________________ (Name of scholarship awardee)

along with an interest thereon at such rate as may be determined by the Government. We bind ourselves and our respective heirs, executors and representatives

Dated this ________________________________ day of ________________________________

two thousand ________________________________ where as the above bounden

______________________________________________

(Name of the scholarship awardee)
has been nominated by the Government of ____________________________ under the
______________________________________________________________
(Name of the Scholarship/Fellowship)

inter alia on his agreeing to execute a bond in a manner aforesaid.

NOW THE CONDITION OF THE ABOVE WRITTEN OBLIGATION IS THAT:

In the event of the above bounden scholarship awardee

a) failing to avail himself/herself of the passage to and/or from the country where he/she is to receive
the training of studies conveyed to his/her nomination to the said scholarship; or

b) not conforming to the instructions regarding training for studies conveyed to his/her by
representative of the Government; or

c) failing to intimate to the Government the amount and other particulars in respect of any
honorarium or other money earned or received by him/her during the period of his/her
training/studies abroad; or

d) refusing to hand over and surrender to the Government the whole part of such honorarium or
other moneys received by him/her as aforesaid, if and when required to do so by the Government; or

e) returning to India without completing the course for which he/she has been selected; or

f) getting adverse reports regarding the progress of his/her conduct; or

g) on completion of his/her training or studies failing to return to India or failing to report his/her
arrival in India to the Government within two weeks of such arrival; or

h) in the event of contracting on infectious disease requiring prolonged hospitalisation, forbidding
the medical advisers/attendants from communicating the nature and condition of disease to Indian
Mission concerned or Government; or

i) failing to return to India after the expiry of the period of scholarships; or

Provided always and it is hereby agreed and declared that the decision of the Government
as to whether the said scholarship awardee has or has not performed and observed any of the
obligations and conditions recited before and as to the sum of money to be refunded or paid shall
be final and binding on the parties hereto.

Provided further that the liability of the sureties hereunder shall not be impaired or discharged by
reason of time being granted or any forbearance, act of omission of the Government (with or
without the knowledge or consent of the sureties in respect of or in relation to the several
obligations nor shall it be necessary for the Government to sue the scholarship awardee before
suing the sureties for amounts due hereunder and provided further that this bond shall in all
respects be governed by the laws of India, the expenses of stamp duty on the bond, if any, shall be
borne by the Government.
In witness thereof the said scholarship awardee and the said sureties have put their respective hand the day and the year herein above written.

Signed and delivered by the within named scholarship awardee in the presence of

(Signature of scholarship awardee)
Present Address __________________

Permanent Address __________________

Signed and delivered by the within named surety in the presence of

(Signature with full name and address of surety)
Present Address __________________

Permanent Address __________________

Signed and delivered by the Within name surety in the Presence of

(Signature with full name aid address of surety)
Present Address __________________

Permanent Address __________________
Signature, name designation and full address of the attesting officer with his official seal, if any. The officer attesting the bond should be Gazetted Officer in the employment of Government or serving as Director/Deputy Director/Registrar/ Professor of all I.I.Ts, all other Institutions deemed to Universities and Professors/Registrars of all Indian Universities/Regional Engineering Colleges.

FOR USE IN THE MINISTRY OF HUMAN RESOURCE DEVELOPMENT (DEPARTMENT OF HIGHER EDUCATION)

Accepted.

(Name and Designation)

For and on behalf of the President of India.
CERTIFICATE OF SOLVENCY

This is to certify that (i) _____________________________________________

Full name with present and

Permanent address of 1st surety)

__________________________________________

(ii) ____________________________________________

(full name with present and permanent address of 2nd surety)

__________________________________________

who have stood sureties to ____________________________________________

(full name and address of scholarship awardee)

__________________________________________

a candidate for award of a Scholarship/ Fellowship

under the ____________________________________________

__________________________________________

is solvent to the extent of the amount stipulated in the Bond executed by the scholarship awardee in respect of the above mentioned award.

__________________________________________

Signature of Collector/
Deputy Commissioner/District
Commissioner/ Deputy Collector/
Tehsildar) of any revenue department.

__________________________________________

(Designation)

Date: ________________

Place: ________________

(Office Seal)
DECLARATION BY SURETIES

Subject: Chinese Government Scholarship - 2019-20 - Declaration by sureties for extended period of scholarship, if any.

We ..............................................................and ..............................................................

The sureties of Sh./Smt./Km./Dr..............................................................

hereby agree and declare that in case the award of scholarship given by the Government of China to the above mentioned stipendiary is extended beyond the period mentioned in it. We will continue to bind ourselves as his/her surety given during the extended period and/or till he/she returns to India after completion of his/her studies/training and also for further period of two years after his/her return to India as per the conditions of the BOND executed by the scholarship awardee and also signed by us as his/her sureties. Hence, while considering grant of extension, if any, in the period of scholarship to the above-mentioned scholarship awardee, no further consent is required to be taken from us.

2. Our present and permanent addresses are given below and in case of any change in the address, undertake to inform the Ministry Immediately

Signature attested *

Signature

1. Present address: ----------------------------------

----------------------------------

----------------------------------

Name (In capital letters)

Designation

With officer stamp

Permanent Address:----------------------------------

----------------------------------

----------------------------------

Contd.../
Signature attested *

B. (Signature of second surety)

Signature

1. Present address:-----------------------------

-----------------------------

Name (In capital letters )
Designation
With office stamp

Permanent address:-----------------------------

-----------------------------

*Signatures of sureties are to be attested by a Gazetted Officer/Director/Deputy Director/Registrar/ Professor of all I.I.T.'s and Institutions deemed to be Universities and all Professor/Registrars of Indian Universities/Regional Engineering Colleges.
DECLARATION
(by the scholar)

I Sh./Smt./Km./…………………………………………………………….. the scholarship awardee, hereby agree and declare that the terms and conditions of the Bond executed by me on ………………….. in favour of the President of India before my departure to ……………………… on the Scholarship awarded to me by the Government of ……………………… for pursuing higher studies/training will remain in force and effect and also binding on me not only during the period of award, i.e. from ………………… to ……………………… but also during the extended period, if any, and even after my return to India.

2. I will request in the prescribed format, my employer, for extension of the scholarship at least 2 months before the expiry of the original scholarship period with copies to the Ministry of Human Resource Development and the Indian Mission in ………………….

3. I understand that, in case of refusal by my employer regarding sanction of leaves for further studies the extension of the scholarship will not be granted by the Ministry of Human Resource Development or ………………… Government.

4. I also understand that the Ministry of Human Resource Development will take a decision on my request for extension, if any, only after receipt of the views of my employer. The Ministry’s decision will be binding upon me and will be final.

(Signature of scholarship awardee)

Signature attested

Present Address:

Signature
(Name in Capital letters)
Designation
With Office Stamp.

Permanent Address:

Note: Strike out para 2, 3 and 4 if you are not employed.
# FOREIGNER PHYSICAL EXAMINATION FORM

<table>
<thead>
<tr>
<th>姓名</th>
<th>Name</th>
<th>性别</th>
<th>Sex</th>
<th>出生日期</th>
<th>Birthday</th>
<th>照片</th>
<th>Photo</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td>□ 男</td>
<td>Male</td>
<td></td>
<td></td>
<td>(加盖检查单位印章)</td>
<td>(Stamped Official Stamp)</td>
</tr>
<tr>
<td></td>
<td></td>
<td>□ 女</td>
<td>Female</td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>现在通讯地址</th>
<th>Present mailing address</th>
<th>出生地</th>
<th>Birth place</th>
<th>血型</th>
<th>Blood type</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>国籍或地区</th>
<th>Nationality (or Area)</th>
<th>出生地</th>
<th>Birth place</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>过去是否患有下列疾病：(每项后面请回答“否”或“是”)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Have you ever had any of the following diseases?</td>
</tr>
<tr>
<td>(Each item must be answered “Yes” or “No”)</td>
</tr>
<tr>
<td>Typhus fever □ No □ Yes</td>
</tr>
<tr>
<td>Poliomyelitis □ No □ Yes</td>
</tr>
<tr>
<td>Diphtheria □ No □ Yes</td>
</tr>
<tr>
<td>Scarlet fever □ No □ Yes</td>
</tr>
<tr>
<td>Relapsing fever □ No □ Yes</td>
</tr>
<tr>
<td>Typhoid and paratyphoid fever □ No □ Yes</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>是否患有下列危及公共秩序和安全的病症：(每项后面请回答“否”或“是”)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Do you have any of the following diseases or disorders endangering the public order and security?</td>
</tr>
<tr>
<td>(Each item must be answered “Yes” or “No”)</td>
</tr>
<tr>
<td>Toxicomania...........................................................................□ No □ Yes</td>
</tr>
<tr>
<td>Mental confusion......................................................................□ No □ Yes</td>
</tr>
<tr>
<td>Manic psychosis.......................................................................□ No □ Yes</td>
</tr>
<tr>
<td>Paranoid psychosis....................................................................□ No □ Yes</td>
</tr>
<tr>
<td>Hallucinatory..........................................................................□ No □ Yes</td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>身高</th>
<th>Height</th>
<th>体重</th>
<th>Weight</th>
<th>血压</th>
<th>Blood pressure</th>
</tr>
</thead>
<tbody>
<tr>
<td></td>
<td>CM</td>
<td>Kg</td>
<td></td>
<td>mmHg</td>
<td></td>
</tr>
<tr>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

<table>
<thead>
<tr>
<th>发育情况</th>
<th>Development</th>
<th>营养情况</th>
<th>Nourishment</th>
<th>颈部</th>
<th>Neck</th>
</tr>
</thead>
<tbody>
<tr>
<td>视力</td>
<td>Vision</td>
<td>矫正视力</td>
<td>Corrected vision</td>
<td>眼</td>
<td>Eyes</td>
</tr>
<tr>
<td>左 L</td>
<td>Left L</td>
<td>右 R</td>
<td>Right R</td>
<td></td>
<td></td>
</tr>
<tr>
<td>Colour sense</td>
<td>Skin</td>
<td>皮肤</td>
<td></td>
<td>淋巴结</td>
<td>Lymph nodes</td>
</tr>
<tr>
<td>耳</td>
<td>Ears</td>
<td>鼻</td>
<td>Nose</td>
<td>扁桃体</td>
<td>Tonsils</td>
</tr>
<tr>
<td>心</td>
<td>Heart</td>
<td>肺</td>
<td>Lungs</td>
<td>腹部</td>
<td>Abdomen</td>
</tr>
<tr>
<td>Spine</td>
<td>Extremities</td>
<td>Nervous system</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>-------</td>
<td>-------------</td>
<td>----------------</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Other abnormal findings</td>
<td>Chest X-ray exam (attached chest X-ray report)</td>
<td>ECG</td>
<td></td>
<td></td>
<td></td>
</tr>
<tr>
<td>Laboratory exam (attached test report of AIDS, Syphilis etc)</td>
<td></td>
<td></td>
<td></td>
<td></td>
<td></td>
</tr>
</tbody>
</table>

None of the following diseases of disorders found during the present examination:
- Cholera
- Yellow fever
- Plague
- Leprosy
- Venereal Disease
- Lung tuberculosis
- AIDS
- Psychosis

Suggestion

Signature of physician | Official Stamp | Date
EMPLOYER'S UNDERTAKING

We, the Employers of Sh./Smt./Km./Dr. ________________________________
who is working as .............................................. in
...........................................................................(name of Organization) are aware that
Sh./Smt./Km./Dr. .............................................................. has been awarded the Chinese
Government Scholarship 2019-20 and undertake to grant him/her leave on his/her request
from .....................to ..................... and for the further extended period of scholarship as
per the policy of the organization.

(Signature)

Name : ........................................
Designation : ........................................
Full address of the employer with rubber stamp
.............................................................................

Station : 
Dated : 


JOINING REPORT

Note: This report must be filled by you in duplicate and submitted through your Supervisor to the Indian Embassy/High Commission immediately after your joining the Institution. In case of any extension of duration of study period in future, prior approval of this Ministry must be obtained.

1. Name of Scholar (in capital letters) : 
2. Mailing Address:
   (a) Present Address (abroad) : 
   (b) Permanent Address (India) :
3. Name of the Scholarship Scheme :
4. Year of Selection :
5. Date of leaving India :
6. Passport No. :
7. Date of arrival abroad :
8. Date of joining the Institution :
9. Course of studies/Level of Course :
10. Address of Institution (in full for Correspondence purpose) :
11. Degree, if any to be obtained at the end of course :
12. Practical Training, if any to be part of course :
13. Duration of the Course :

Date: (Signature of Scholar)

Remarks, if any, of Supervising authority :

(Signature of Supervising Authority)

Forwarding remarks of the Office of High Commission/Embassy :

Date: (Signature of forwarding Officer)